

MAC8DG, MAC8MG, MAC8NG





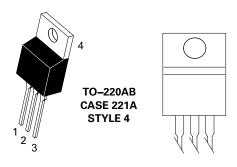
Description

Designed primarily for full-wave ac control applications, such as motor controls, heating controls and power supplies; or wherever half—wave silicon gate—controlled, solid—state devices are needed.

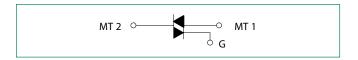
Features

- Blocking Voltage to 800 Volts
- On-State Current Rating of 8.0 Amperes RMS at 100°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dv/ dt – 250 V/μs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220 Package
- High Commutating di/ dt – 6.5 A/ms minimum at 125°C
- These Devices are Pb-Free and are RoHS Compliant

Pin Out



Functional Diagram



Additional Information







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Maximum Ratings (T₁ = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit	
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T _J = -40° to 150°C) MAC8MG MAC8MG MAC8NG		V _{DRM} ,	400 600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, T _c = 100°C)	I _{T (RMS)}	8.0	А	
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _C = 125°C)	I _{TSM}	80	А	
Circuit Fusing Consideration (t = 8.3 ms)	l²t	26	A²sec	
Peak Gate Power (Pulse Width ≤ 1.0 µs, T _C = 80°C)	P _{GM}	16	W	
Average Gate Power ($T_J = 80^{\circ}\text{C}$)	P _{G(AV)}	0.35	W	
Operating Junction Temperature Range	T _J	-40 to +125	°C	
Storage Temperature Range		T _{stg}	-40 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied.

Thermal Characteristics

Rating	Symbol	Value	Unit	
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient	R _{ejc} R _{eja}	1.8 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds		T_{\scriptscriptstyleL}	260	°C

Electrical Characteristics - OFF (T, = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	T, = 25°C	I _{DRM} ,	-	-	0.01	m A
$(V_D = V_{DRM} = V_{RRM}; Gate Open)$	$T_{J} = 125^{\circ}C$	I _{RRM}	-	-	2.0	mA mA

Electrical Characteristics - ON $(T_1 = 25^{\circ}\text{C unless otherwise noted; Electricals apply in both directions)$

Characteristic		Symbol	Min	Тур	Max	Unit
Peak On-State Voltage (Note 4) (I _{TM} = ±6.0 A)		V _{TM}	-	1.3	1.6	V
Gate Trigger Current	MT2(+), G(+)		5.0	13	5.0	
(Continuous dc)	MT2(+), G(-)	l _{GT}	5.0	16	5.0	mA
$(V_D = 12 \text{ V}, R_L = 100 \Omega)$	MT2(-), G(-)		5.0	18	5.0	
Holding Current ($V_D = 12 \text{ V}$, Gate Open, Initiating Current = $\pm 150 \text{ mA}$))		I _H	-	1.5	1.5	mA
Gate Non–Trigger Voltage (Continuous dc) – ($V_D = 12 \text{ V}, R_L = 100 \Omega, T_J = 110^{\circ}\text{C}$)	V _{GD}	-	20	40	V
	MT2(+), G(+)		_	20	50	
Latching Current $(V_D = 24 \text{ V, I}_S = 35 \text{ mA})$	MT2(+), G(-)	I _L	_	30	80	mA
(* _D - 2 : *, 1 _G - 30 : 11 *,	MT2(-), G(-)		_	20	50	
	MT2(+), G(+)	V _{GT}	0.5	0.69	1.5	V
Gate Trigger Voltage $(V_D = 12 \text{ V}, R_I = 100 \Omega)$	MT2(+), G(-)		0.5	0.77	1.5	
(v _D = 12 v, 11 _L = 100 12)	MT2(-), G(-)		0.5	0.72	1.5	
Gate Non-Trigger Voltage			0.2	_	_	
$(T_{J} = 125^{\circ}C)$	MT2(+), G(-)	V _{GD}	0.2	-	_	V
$(V_D = 12 \text{ V}, R_L = 100 \Omega)$	MT2(-), G(-)		0.2	-	-	

^{2.} Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



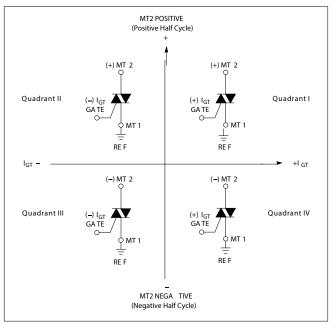
Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current See Figure 10.($V_D = 400 \text{ V}$, $I_{TM} = 4.4 \text{ A}$, Commutating dv/dt = 18 V/µs,Gate Open, TJ = 125°C, f = 250 Hz, No Snubber) $C_L = 10 \text{ µF } L_L = 40 \text{ mH}$	dV/dt	6.5	_	_	A/ms
Critical Rate of Rise of Off-State Voltage $(V_D = Rated V_{DRM'} Exponential Waveform, Gate Open, T_J = 125°C)$	dV/dt	250	-	_	V/µs

Voltage Current Characteristic of SCR

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current

Quadrant Definitions for a Triac



All polarities are referenced to MT1. With in–phase signals (using standard AC lines) quadrants I and III are used

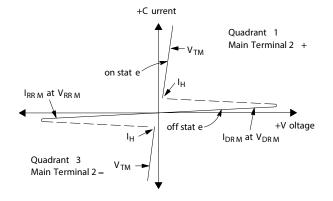
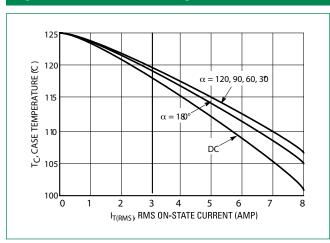


Figure 2. On-State Power Dissipation



Figure 1. RMS Current Derating



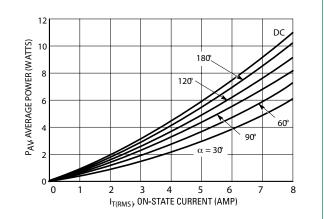


Figure 3. On-State Characteristics

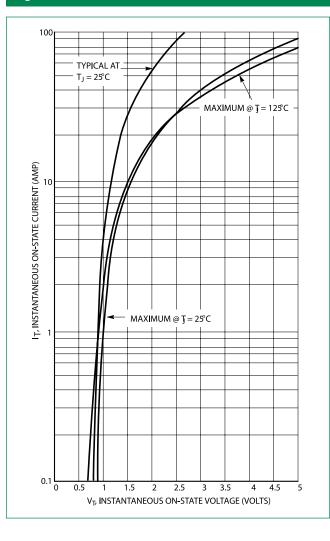


Figure 4. Thermal Response

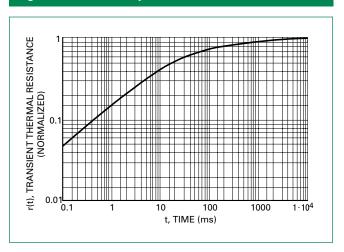
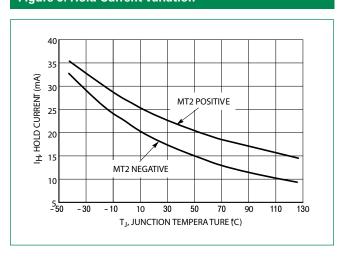


Figure 5. Hold Current Variation







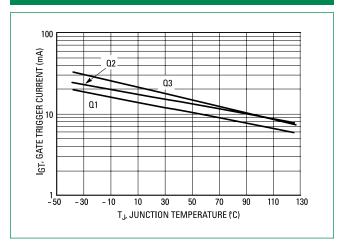


Figure 7. Gate Trigger Voltage Variation

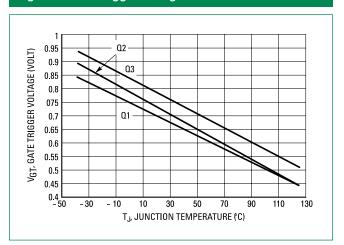


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential)

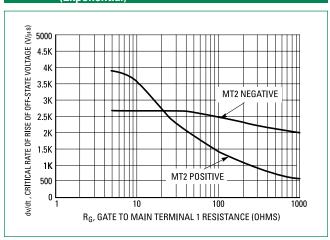


Figure 9. Critical Rate of Rise of Commutating Voltage

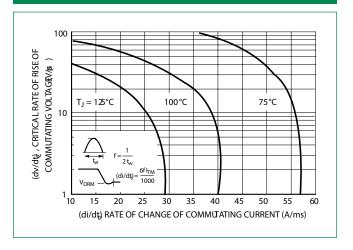
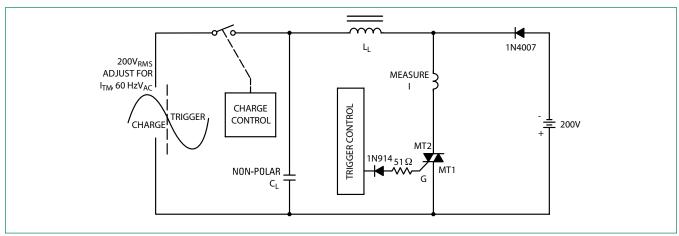


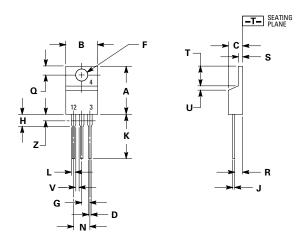
Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)



Note: Component values are for verification of rated (di/dt)_€. See AN1048 for additional information.

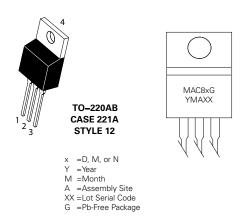


Dimensions



Part Marking System

Ordering Information



D:	Inches		Millin	neters
Dim	Min	Max	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
Н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
K	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
Q	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045		1.15	
Z		0.080		2.04

Pin Assignment			
1	Main Terminal 1		
2	Main Terminal 2		
3	Gate		
4	No Connection		

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Device	Package	Shipping
MAC8DG		
MAC8MG	TO-220AB (Pb-Free)	500 Units / Rail
MAC8NG	(, , , , , , , , , , , , , , , , , , ,	

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.